

() Prelim	inary	Specifi	cations
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(V) Final Specifications

Module	10.1" SD+ 16:9 Color TFT-LCD	
Model Name	B101EW01 V0	
Note (🗭)	LED Backlight with driving circuit design	

Customer	Date	Approved by	Date
<u>All</u>	<u>5/7/2009</u>		5/7/2009
Checked & Approved by	Date	Prepared by	
			5/7/2009
Note: This Specification is sunotice.	bject to change without	NBBU Marketing AU Optronics o	



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Record of Revision

Version and Date	Page	Old description	New Description	Remark
0.1 2008/12/29	All	First Edition for Customer		
1.0 2008/3/27	All	Final Edition		
2.0 2009/05/07	26	HW control table [Radium IC]	HW control table [Novatek IC]	
	27	Carton Package (1 layer)	Carton Package (2 layer)	



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1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11) After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostatic breakdown.



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2. General Description

B101EW01 V0 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support 1280(H) x 720(V) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B101EW01 V0 is designed for a display unit of notebook style personal computer and industrial machine.

2.1 General Specification

The following items are characteristics summary on the table at 25 $^{\circ}\mathrm{C}$ condition:

Items	Unit	Specifications				
Screen Diagonal	[mm]	255.54(10.1W")				
Active Area	[mm]	222.72(H) X	125.28(V)			
Pixels H x V		1280x3(RGB	s) x 720			
Pixel Pitch	[mm]	0.1740 (H) x	0.1740 (V)			
Pixel Arrangement		R.G.B. Vertic	al Stripe			
Display Mode		Normally Wh	ite			
White Luminance Note: ILED is LED current	[cd/m ²]	180 typ (Note1)				
Luminance Uniformity (5P)		1.25 max				
Contrast Ratio		500 typ				
Response Time	[ms]	16 typ				
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	Тур	Max	Note)	
		2.7W	2.9W	Type I , V _{in} =	:12V	
		3.1W	3.3W	Type I , V _{in} =	:5V	
Weight	[Grams]	175 max.				
Physical Size	[mm]		L	W	Т	
(w/ bracket & PCBA)				3.6		
		Typical 243.0 146.5				
		Min	242.5	146.0	-	
Electrical Interface		1 channel LW	DS		,	



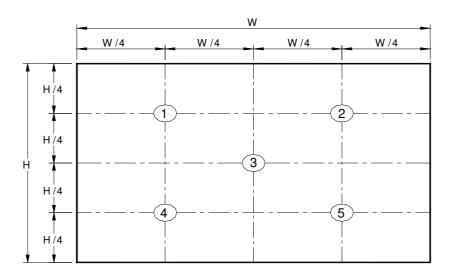
Glass Thickness	[mm]	0.5
Surface Treatment		Glare
Support Color		262K colors (RGB 6-bit)
Temperature Range Operating Storage (Non-Operating)	[°C]	0 to +50 -20 to +60
RoHS Compliance		RoHS Compliance

2.2 Optical Characteristics The optical characteristics are measured under stable conditions at 25 $^{\circ}$ C (Room Temperature) :

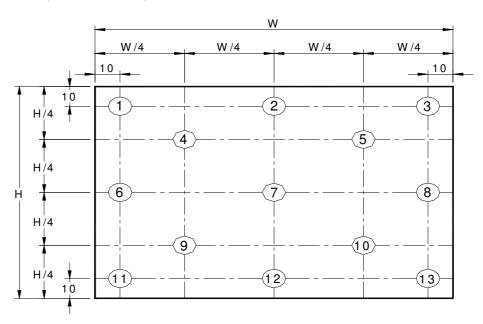
Item		Symbol	Conditi	Conditions		Тур.	Max.	Unit	Note
White Luminance ILED=20mA			5 points average		153	180	-	cd/m ²	1, 4, 5
Viewing Angle		heta R $ heta$ L	Horizontal CR = 10	(Right) (Left)	40 40	45 45	-	degree	4.0
		∲ н ∳ ∟	Vertical CR = 10	(Upper) (Lower)	10 30	15 35	-		4, 9
Luminan Uniformi		δ 5P	5 Poir	nts	-	-	1.25		1, 3, 4
Luminance Uniformity		δ _{13P}	13 Points		-	ı	1.60		2, 3, 4
Contrast Ratio		CR			400	500	-		4, 6
Cross talk		%					4		4, 7
		T_r	Rising		-	12	-		
Response 7	Гіте	T_f	Falling		-	4	-	msec	4, 8
		T _{RT}	Rising + Falling		-	16	•		
Red		Rx			0.551	0.581	0.611		
	Hea	Ry			0.307	0.337	0.367		
	Green	Gx			0.302	0.332	0.362		
Color / Chromaticity	Green	Gy			0.545	0.575	0.605		
Coodinates	Blue	Вх	CIE 19	931	0.130	0.160	0.190		4
	Diue	Ву			0.108	0.138	0.168		
	White	Wx			0.283	0.313	0.343		
	Wille	Wy			0.299	0.329	0.359		
NTSC		%			-	45	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



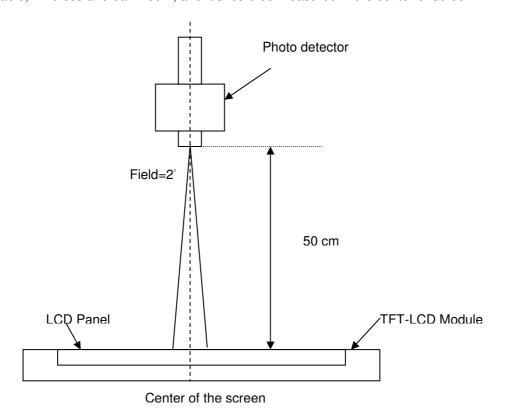
Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

2		Maximum Brightness of five points
δ w5	= '	Minimum Brightness of five points
2		Maximum Brightness of thirteen points
δ w13	=	Minimum Brightness of thirteen points



Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



Note 5: Definition of Average Luminance of White (Y_L):

Measure the luminance of gray level 63 at 5 points \cdot $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

Note 6: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Brightness on the "White" state Contrast ratio (CR)= Brightness on the "Black" state

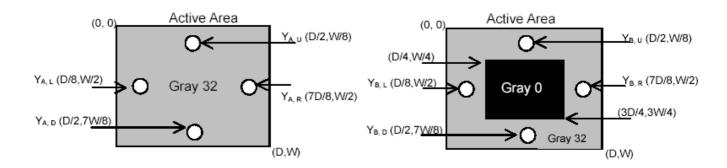
Note 7: Definition of Cross Talk (CT)

$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

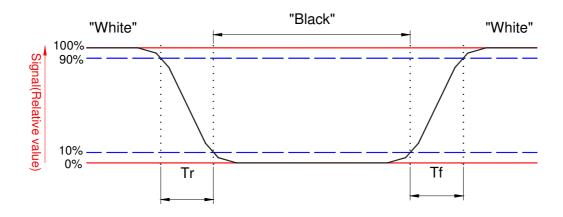
 $Y_A =$ Luminance of measured location without gray level 0 pattern (cd/m₂)

 Y_B = Luminance of measured location with gray level 0 pattern (cd/m₂)



Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.

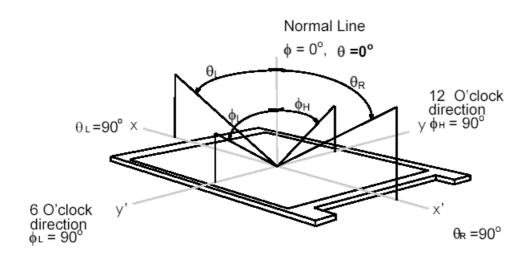




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Note 9. Definition of viewing angle

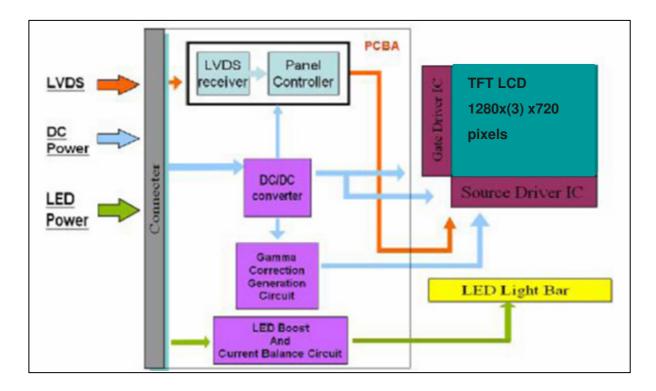
Viewing angle is the measurement of contrast ratio \geq 10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° (θ) horizontal left and right and 90° (Φ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





3. Functional Block Diagram

The following diagram shows the functional block of the 10.1 inches wide Color TFT/LCD 40 Pin (One ch/connector Module).





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4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

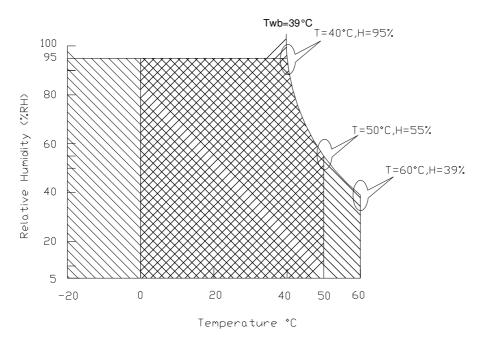
The first control of the control of								
Item	Symbol	Min	Max	Unit	Conditions			
Operating Temperature	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	5	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+60	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+



5. Electrical characteristics

5.1 TFT LCD Module

5.1.1 Power Specification

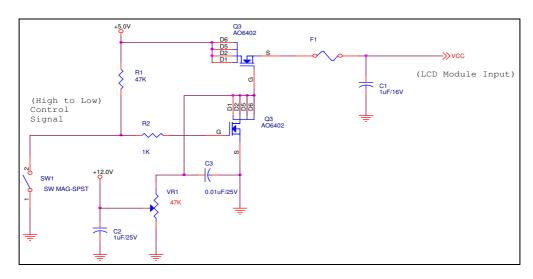
Input power specifications are as follows;

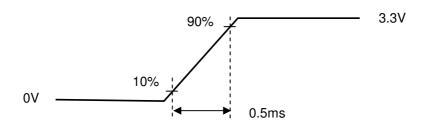
Symble	Parameter	Min	Тур	Max	Unit	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	_	0.7	0.8	[Watt	Note 1/2
IDD	IDD Current	-	-	250	[mA]	Note 1/2
IRush	Inrush Current	-	•	1500	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	100	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

Note 3: Measure Condition





Vin rising time

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5.1.2 Signal Electrical Characteristics

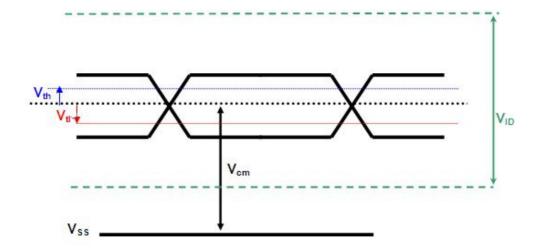
Input signals shall be low or High-impedance state when VDD is off.

It is recommended to refer the specifications of SN75LVDS82DGG (Texas Instruments) in detail.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
V _{th}	Differential Input High Threshold (Vcm=+1.2V)		100	[mV]
V _{tl}	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
V _{ID}	Differential Input Voltage	100	600	[mV]
V _{cm}	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform





5.2.1 LED characteristics

Parameter	Symbol	Min	Тур	Max	Units	Condition
Backlight Power Consumption	PLED	-	2.0	2.1	[Watt]	(Ta=25°C), Note 1 Type I , V _{in} =12V
Condamption		-	2.4	2.5	[Watt]	(Ta=25°C), Note 1 Type II , V _{in} =5V
LED Life-Time	N/A	12,000	-	-	Hour	(Ta=25°C), Note 2
						I _F =20 mA

P_{LED} = VF (Normal Distribution) * IF (Normal Distribution) / Efficiency Note 1: Calculator value for reference

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous

Note 3: This panel will support lower duty ratio at PWM conditional frequency. The PWM frequency constrain between 100 Hz to 300 Hz and a same typical 200Hz. The duty ratio support from 5% to 100%.

5.2.2 Backlight input signal characteristics

Parameter	Symbol	Min	Тур	Max	Units	Remark
LED Dower Cumply	VIED	6.0	12.0	21.0	[Volt]	Type I, Note 1
LED Power Supply	VLED	4.5	5	5.5	[Volt]	Type II, Note 1
LED Enable Input High Level		2.5	-	5.5	[Volt]	
LED Enable Input Low Level	VLED_EN	-	-	0.8	[Volt]	
PWM Logic Input High Level	VPWM_EN	2.5	-	5.5	[Volt]	
PWM Logic Input Low Level		-	-	0.8	[Volt]	
PWM Input Frequency	FPWM	100	-	1K	Hz	
PWM Duty Ratio	Duty	5		100	%	PWM Frequency
PWM Duty Ratio	Duty	15		100	%	PWM Frequency ≥500 Hz

Note 1: Type I and II is an independent of design parameter. It should be separated from system design.



6. Signal Characteristic

6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1				1280
1st Line	R G B	R G B		R G B	R G B
			*		
	'	'		•	i i
					:
	'		•	•	·
	.		*		
	'		'	'	'
720th Line	R G B	R G B		R G B	R G B



6.2 The input data format

RxCLKIN	
RxIN0	G0 R5 R4 R3 R2 R1 R0
RxIN1	B1 B0 G5 G4 G3 G2 G1
RxIN2	DE VS HS B5 B4 B3 B2

	T	T
Signal Name	Description	
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	, ,	
	Red-pixel Data	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	·
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	,	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	Blue-pixel Data	
RxCLKIN	Data Clock	The typical frequency is 54.2MHZ.The signal is
		used to strobe the pixel data and DE signals. All
		pixel data shall be valid at the falling edge when
		the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



6.3 Integration Interface Requirement

6.3.1 Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20455-040E-12 or compatible
Mating Housing/Part Number	IPEX 20453-040T-11 or compatible

6.3.2 Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

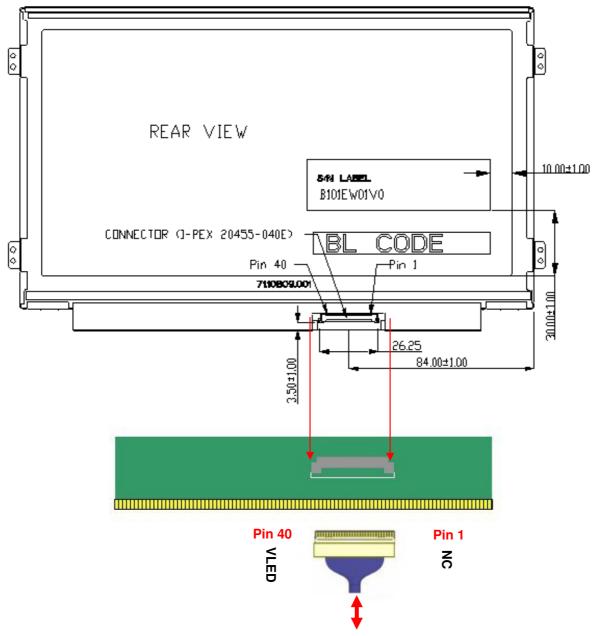
Pin	Signal	Description
1	GND	Ground
2	AVDD	Power Supply +3.3V
3	AVDD	Power Supply +3.3V
4	VEDID	EDID +3.3V Power
5	NC	No Connection (Reserve)
6	CLK_EDID	EDID Clock Input
7	DAT_EDID	EDID Data Input
8	Rin0-	-LVDSdifferential data input(R0-R5,G0)
9	Rin0+	+LVDSdifferential data input(R0-R5,G0)
10	GND	Ground
11	Rin1-	-LVDSdifferential data input(G1-G5,B0-B1)
12	Rin1+	+LVDSdifferential data input(G1-G5,B0-B1)
13	GND	Ground
14	Rin2-	-LVDSdifferential data input(B2-B5,HS,VS,DE)
15	Rin2+	+LVDSdifferential data input(B2-B5,HS,VS,DE)
16	GND	Ground
17	ClkIN-	-LVDSdifferential clock input
18	ClkIN+	+LVDSdifferential clock input
19	GND	Ground-Shield
20	NC	No Connection (Reserve)
21	NC	No Connection (Reserve)
22	GND	Ground-Shield
23	NC	No Connection (Reserve)
24	NC	No Connection (Reserve)
25	GND	Ground-Shield
26	NC	No Connection (Reserve)
27	NC	No Connection (Reserve)
28	GND	Ground-Shield
29	NC	No Connection (Reserve)



30	NC	No Connection (Reserve)
31	VLED_GND	LED Ground
32	VLED_GND	LED Ground
33	VLED_GND	LED Ground
34	NC	No Connection (Reserve)
35	VPWM_EN	System PWM Logic Input Level
36	VLED_EN	LED enable input level
37	NC	No Connection (Reserve)
38	VLED	LED Power Supply
39	VLED	LED Power Supply
40	VLED	LED Power Supply

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

Note1: Start from right side



Note1: Input signals shall be low or High-impedance state when VDD is off.



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6.4 Interface Timing

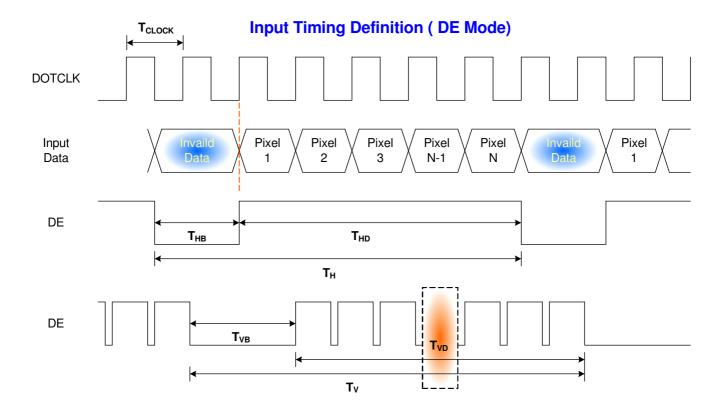
6.4.1 Timing Characteristics

Basically, interface timings should match the 1280 x 720 /60Hz manufacturing guide line timing.

Parameter		Symbol	Min.	Тур.	Max.	Unit	
Frame	Frame Rate			60		Hz	
Clock from	equency	1/ T _{Clock}	57.2	61.5	80	MHz	
	Period	T _V	728	736	1023		
Vertical Section	Active	T _{VD}	720	720	720	T_Line	
	Blanking	T _{VB}	8	16	303		
	Period	T _H	1310	1408	2047		
Horizontal	Active	T _{HD}	1280	1280	1280	T _{Clock}	
Section	Blanking	T _{HB}	30	128	767		

Note: DE mode only

6.4.2 Timing diagram



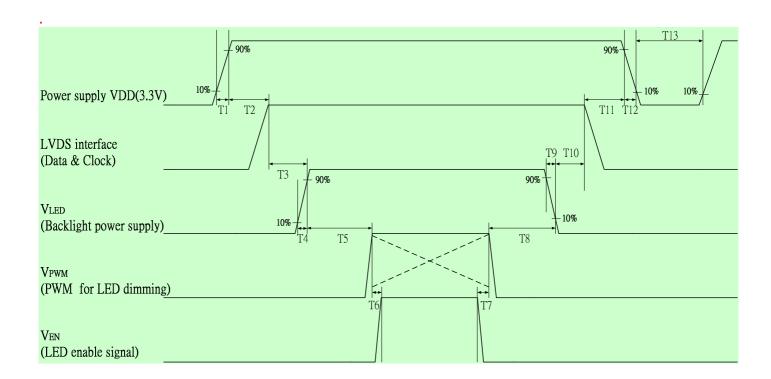


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6.5 Power Sequence

6.5.1 Panel Power Sequence

VDD power and LED on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off.



Power Sequence Timing							
Parameter	Min.(ms)	Typ.(ms)	Max.(ms)	Condition			
T1	0.5	-	10				
T2	0	-	50				
Т3	200	-	-				
T4	0.5	-	10				
T5	10	-	-				
Т6	10	-	-				
Т7	0	-	-				
Т8	10		200	VLED=6~21V(Type I)			
10	10	-	-	VLED=5V(type II)			
Т9	0	-	10				
T10	200	-	-				
T11	0.5	-	50				
T12	0	-	10				
T13	400	-	-				



7. Panel Reliability Test

7.1 Vibration Test

Test Spec:

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

7.2 Shock Test

Test Spec:

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side

7.3 Reliability Test

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LSD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

. Self-recoverable. No hardware failures.

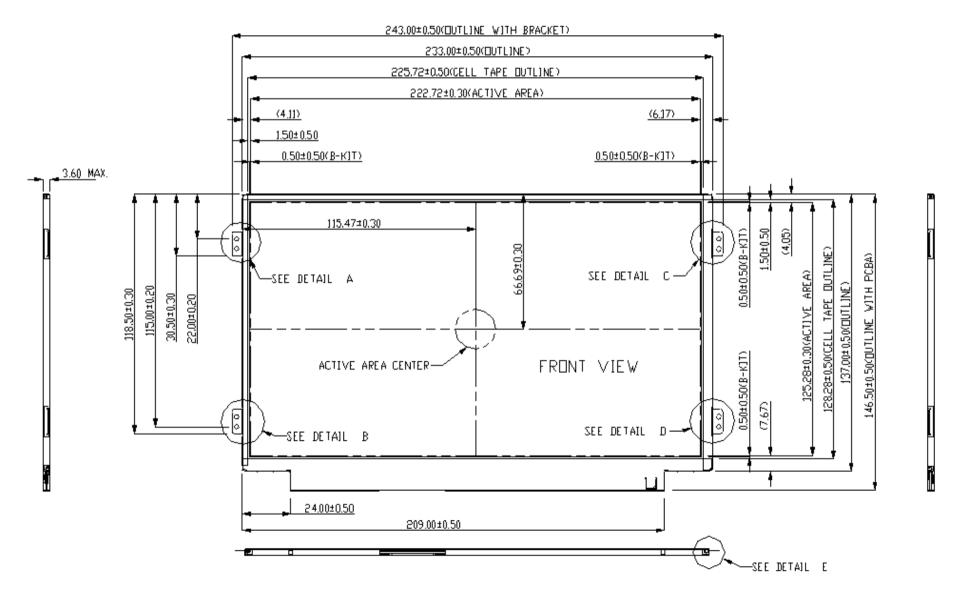
Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



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8. Mechanical Characteristics

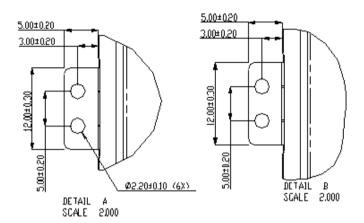
8.1 LCM Outline Dimension

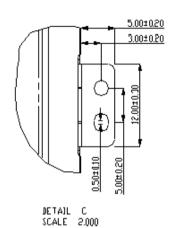


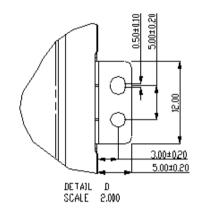
B101EW01 V0 document version : 2.0 23 of 30

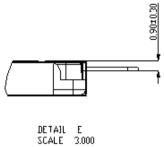


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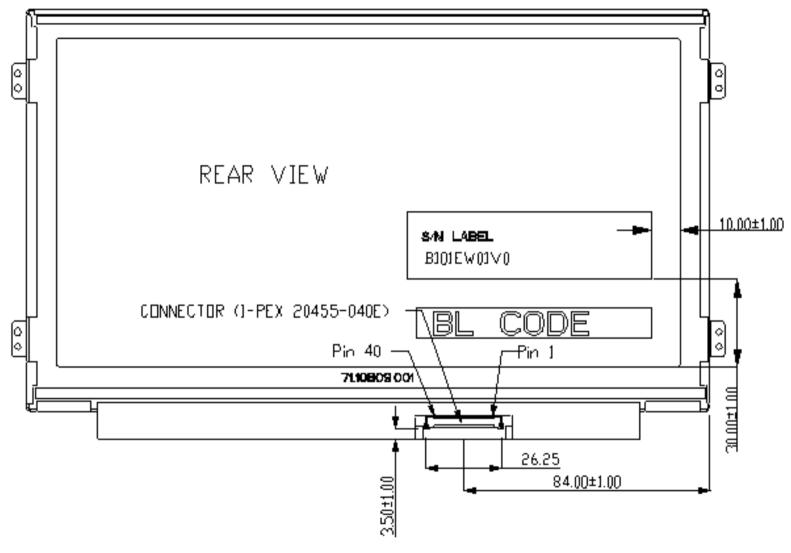




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9. Shipping and Package

9.1 Shipping Label Format



Manufactured 09/06 Model No: B101 EW01 V1 **AU Optronics** MADE IN China (S1)

H/W: 0A F/W:1

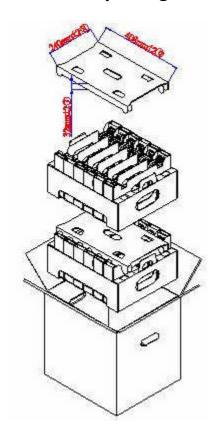


* H/W code control table :

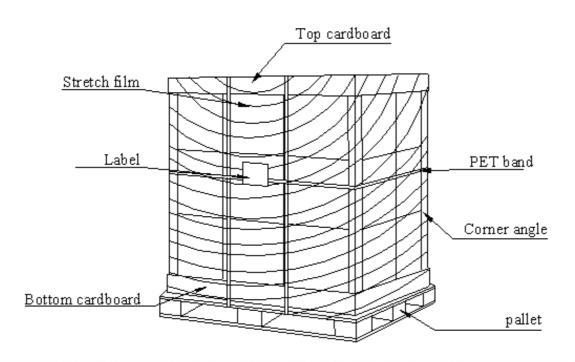
IC Combination		Control Code	H/W	
Source	Novatek	OAXXG	OA	
Gate	Novatek	UAXXG	OA	



9.2 Carton package



9.3 Shipping package of palletizing sequence





10. Appendix: EDID description

B101EW01 V0 EDID Code

Address	FUNCTION	Value	Value	Value
HEX		HEX	BIN	DEC
00	Header	00	00000000	0
01		FF	11111111	255
02		FF	11111111	255
03		FF	11111111	255
04		FF	11111111	255
05		FF	11111111	255
06		FF	11111111	255
07		00	00000000	0
08	EISA Manuf. Code LSB	06	00000110	6
09	Compressed ASCII	AF	10101111	175
0A	Product Code	D5	11010101	213
0B	hex, LSB first	10	00010000	16
0C	32-bit ser #	00	00000000	0
0D		00	00000000	0
0E		00	00000000	0
0F		00	00000000	0
10	Week of manufacture	01	0000001	1
11	Year of manufacture	13	00010011	19
12	EDID Structure Ver.	01	0000001	1
13	EDID revision #	03	00000011	3
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128
15	Max H image size (rounded to cm)	16	00010110	22
16	Max V image size (rounded to cm)	0D	00001101	13
17	Display Gamma (=(gamma*100)-100)	78	01111000	120
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10
19	Red/green low bits (Lower 2:2:2:2 bits)	D1	11010001	209
1 A	Blue/white low bits (Lower 2:2:2:2 bits)	15	00010101	21
1B	Red x (Upper 8 bits)	94	10010100	148
1C	Red y/ highER 8 bits	56	01010110	86
1D	Green x	55	01010101	85
1E	Green y	93	10010011	147
1F	Blue x	29	00101001	41
20	Blue y	23	00100011	35
21	White x	50	01010000	80
22	White y	54	01010100	84
23	Established timing 1	00	00000000	0
24	Established timing 2	00	00000000	0
25	Established timing 3	00	00000000	0
26	Standard timing #1	01	0000001	1
27		01	0000001	1



47	Signal (non-intr, norm, no stero, sep sync, neg	18	00011000	24
46	Vertical Border (zero for internal LCD)	00	00000000	0
45	Horizontal Border (zero for internal LCD)	00	00000000	0
44	Horizontal & Vertical Image Size (upper 4:4 bits)	00	00000000	0
43	Vertical Image Size Lower 8bits	7D	01111101	125
42	Horizontal Image Size Lower 8bits	DE	11011110	222
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0
40	VertSync.Offset : VertSync.Width	36	00110110	54
3F	HorzSync.Width	20	00100000	32
3E	HorzSync. Offset	30	00110000	48
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	20	00100000	32
3C	Vertical Blanking Lower 8bits	10	00010000	16
3B	Vertical Active Lower 8bits	D0	11010000	208
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80
39	Horz blanking Lower 8bits	70	01110000	112
38	Horz active Lower 8bits	00	00000000	0
37	Pixel Clock/10000 USB	18	00011000	24
36	Pixel Clock/10000 LSB	06	00000110	6
35	Divid Olask/40000 LOD	01	00000001	1
34	Standard timing #8	01	00000001	1
33		01	0000001	1
32	Standard timing #7	01	0000001	1
31		01	0000001	1
30	Standard timing #6	01	0000001	1
2F		01	0000001	1
2E	Standard timing #5	01	0000001	1
2D		01	0000001	1
2C	Standard timing #4	01	0000001	1
2B		01	0000001	1
2A	Standard timing #3	01	0000001	1
		01	0000001	1
29	Standard timing #2	01	0000001	1



56		00	00000000	0
57		00	00000000	0
58		00	00000000	0
59		20	00100000	32
5A	Detailed timing/monitor	00	0000000	0
5B	descriptor #3	00	00000000	0
5C	3333p.to: #3	00	00000000	0
5D		FE	11111110	254
5E		00	00000000	0
5F	Manufacture	41	01000001	65
60	Manufacture	55	01010101	85
61	Manufacture	4F	01001111	79
62		0A	00001010	10
63		20	00100000	32
64		20	00100000	32
65		20	00100000	32
66		20	00100000	32
67		20	00100000	32
68		20	00100000	32
69		20	00100000	32
6A		20	00100000	32
6B		20	00100000	32
6C	Detailed timing/monitor	00	00000000	0
6D	descriptor #4	00	00000000	0
6E		00	00000000	0
6F		FE	11111110	254
70		00	00000000	0
71	Manufacture P/N	42	01000010	66
72	Manufacture P/N	31	00110001	49
73	Manufacture P/N	30	00110000	48
74	Manufacture P/N	31	00110001	49
75	Manufacture P/N	45	01000101	69
76	Manufacture P/N	57	01010111	87
77	Manufacture P/N	30	00110000	48
78	Manufacture P/N	31	00110001	49
79	Manufacture P/N	20	00100000	32
7A	Manufacture P/N	56	01010110	86
7B	Manufacture P/N	30	00110000	48
7C		20	00100000	32
7D		0A	00001010	10
7E	Extension Flag	00	0000000	0
7F	Checksum	C5	11000101	197

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